

- Low Loss SAW Filter
- Surface Mount 3.0 x 3.0 mm Package
- Complies with Directive 2002/95/EC (RoHS)

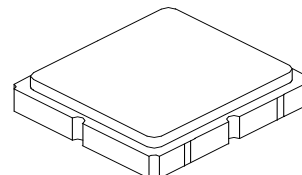


Absolute Maximum Ratings

Rating	Value	Units
Input Power Level	5	dBm
DC Voltage on any Non-ground Terminal	3	V
Operating Temperature Range	-40 to +90	°C
Storage Temperature Range in Tape and Reel	-40 to +90	°C
Maximum Soldering Profile, 5 cycles/10 seconds maximum	265	°C

SF2133E

**1747.5 MHz
SAW Filter**



SM3030-6

Electrical Characteristics

Characteristic	Sym	Notes	Min	Typ	Max -20 to +70 °C	Max -40 to +90 °C	Units
Center Frequency	f_c			1747.5			MHz
Insertion Loss, 1710 to 1785 MHz	IL			2.6	4.0	4.1	dB
Amplitude Ripple, 1710 to 1785 MHz				1.6	2.5	3.0	dB _{P-P}
Attenuation Referenced to 0 dB:							
10 to 1670 MHz			15	23			dB
1670 to 1690 MHz			6	24			
1805 to 1880 MHz			6	24			
1880 to 4500 MHz			15	25			
4500 to 5000 MHz			10	14			
Input/Output VSWR, 1710 to 1785 MHz				1.8:1	2.5:1	2.5:1	
Source Impedance	Z_s			50			Ω
Load Impedance	Z_L			50			Ω
Case Style	SM3030-6 3.0 x 3.0 mm Nominal Footprint						
Lid Symbolization (Y=year, WW=week, S=shift) dot=pin 1 indicator	679, YWWS						
Standard Reel Quantity	Reel Size 7 Inch	500 Pieces/Reel					
	Reel Size 13 Inch	3000 Pieces/Reel					

Electrical Connections

Connection	Terminals
Input	2
Output	5
Case Ground	All others

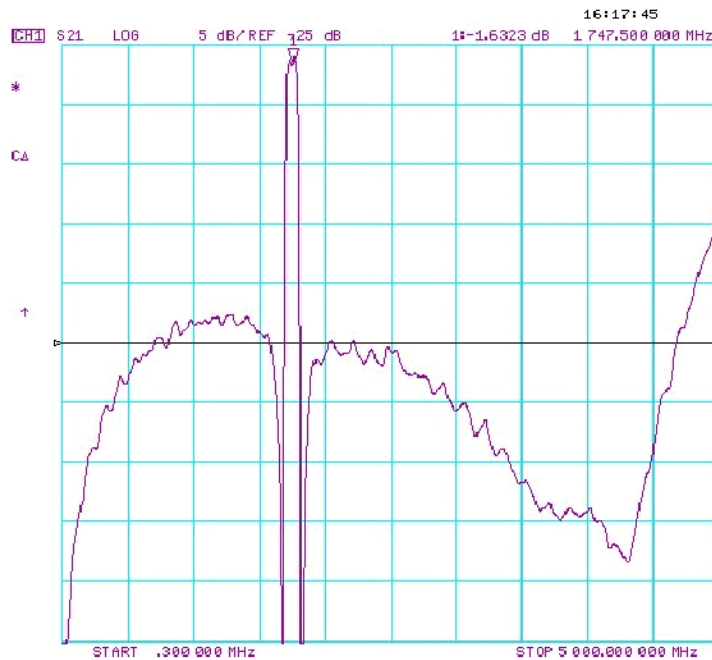
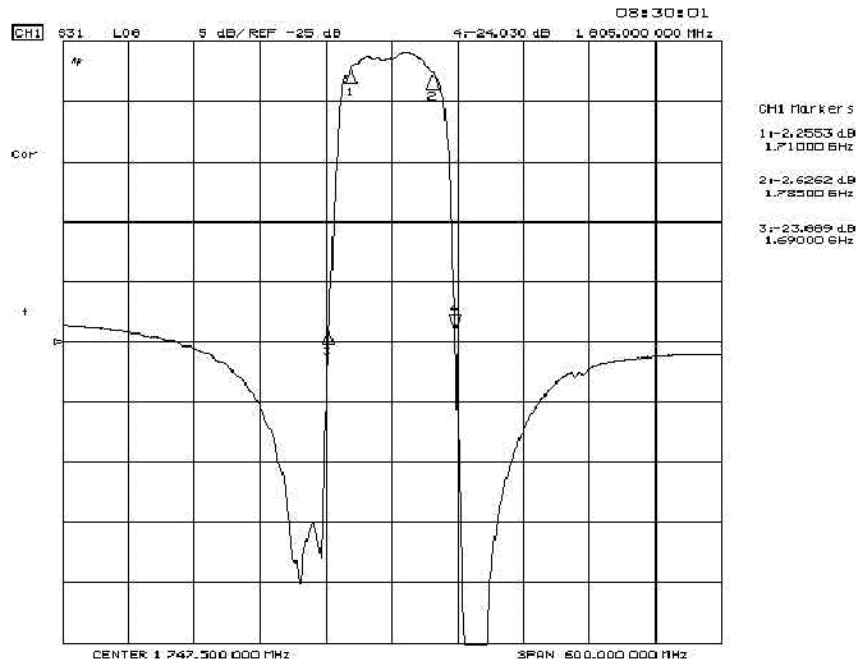


CAUTION: Electrostatic Sensitive Device. Observe precautions for handling.

NOTES:

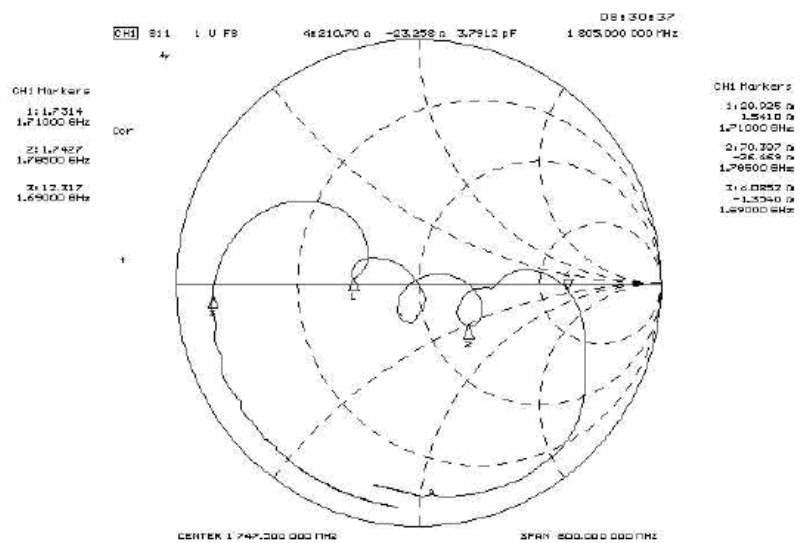
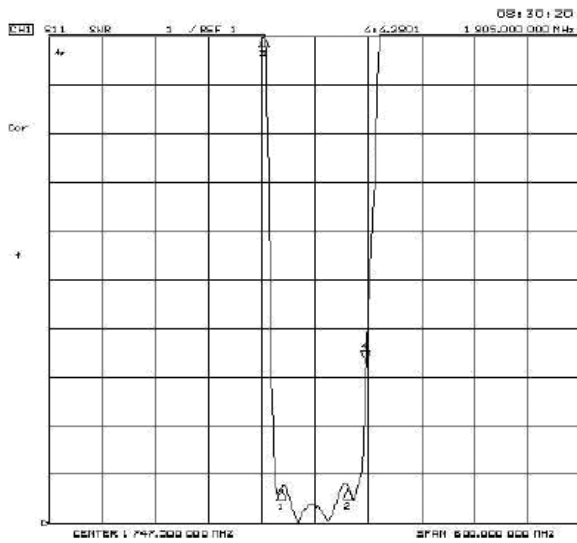
1. The design, manufacturing process, and specifications of this device are subject to change.
2. US or International patents may apply.

F. Frequency Characteristics :
Transfer function

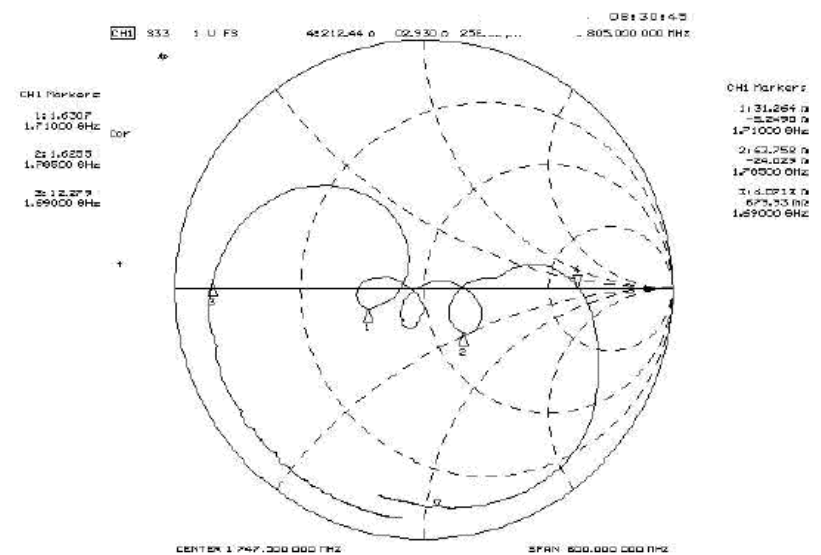
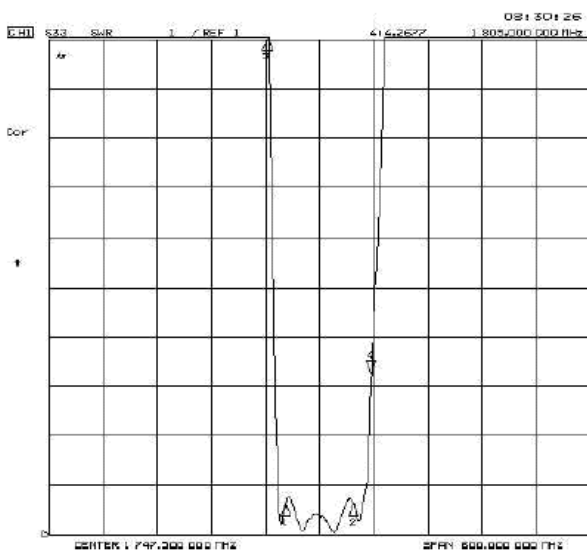


Reflections Functions :

S11



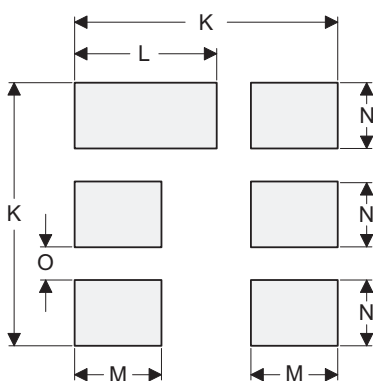
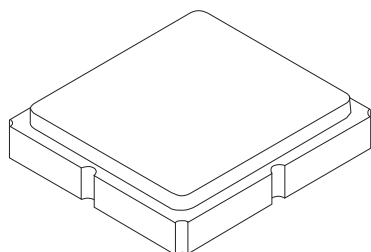
S22



SM3030-6 Case

6-Terminal Ceramic Surface-Mount Case

3.0 X 3.0 mm Nominal Footprint



PCB Footprint Top View

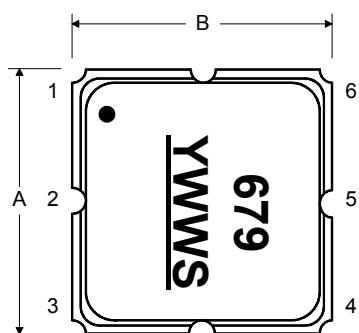
Case and PCB Footprint Dimensions

Dimension	mm			Inches		
	Min	Nom	Max	Min	Nom	Max
A	2.87	3.00	3.13	0.113	0.118	0.123
B	2.87	3.00	3.13	0.113	0.118	0.123
C	1.12	1.25	1.38	0.044	0.049	0.054
D	0.77	0.90	1.03	0.030	0.035	0.040
E	2.67	2.80	2.93	0.105	0.110	0.115
F	1.47	1.60	1.73	0.058	0.063	0.068
G	0.72	0.85	0.98	0.028	0.033	0.038
H	1.37	1.50	1.63	0.054	0.059	0.064
I	0.47	0.60	0.73	0.019	0.024	0.029
J	1.17	1.30	1.43	0.046	0.051	0.056
K		3.20			0.126	
L		1.70			0.067	
M		1.05			0.041	
N		0.81			0.032	
O		0.38			0.015	

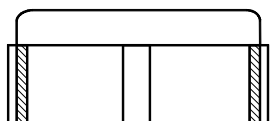
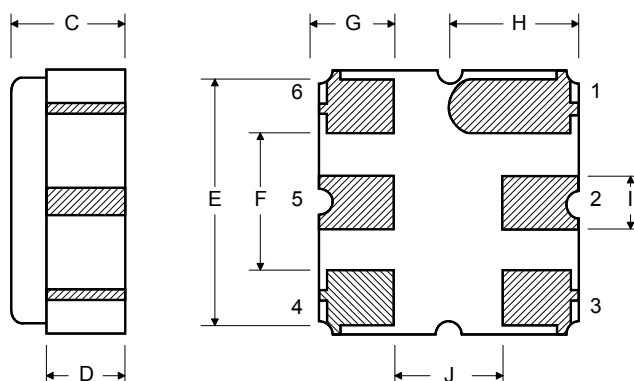
Case Materials

Materials	
Solder Pad Plating	0.3 to 1.0 μ m Gold over 1.27 to 8.89 μ m Nickel
Lid Plating	2.0 to 3.0 μ m Nickel
Body	Al ₂ O ₃ Ceramic
Pb Free	

Top View

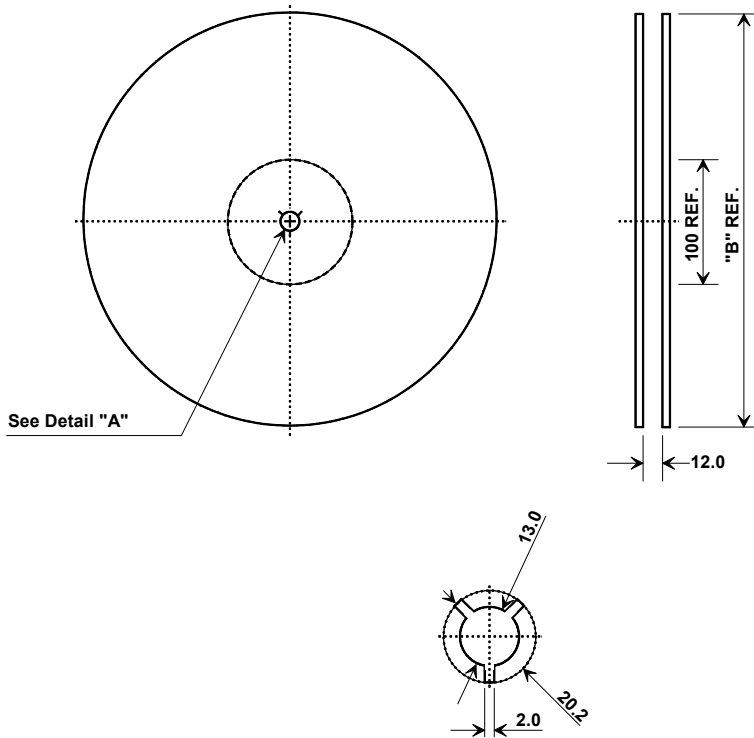


Bottom View



Tape and Reel Specifications

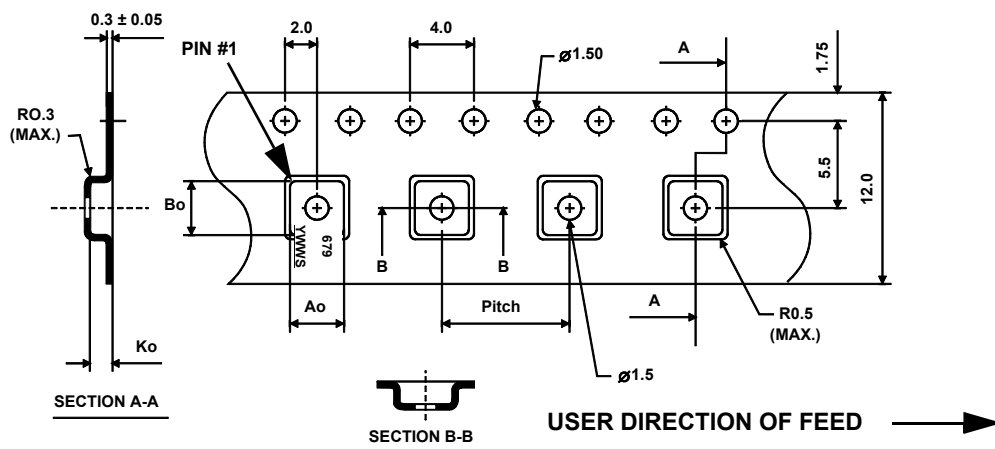
Tape and Reel Standard per ANSI/EIA481



"B"		Quantity Per Reel
Inches	millimeters	
7	178	500
13	330	3000

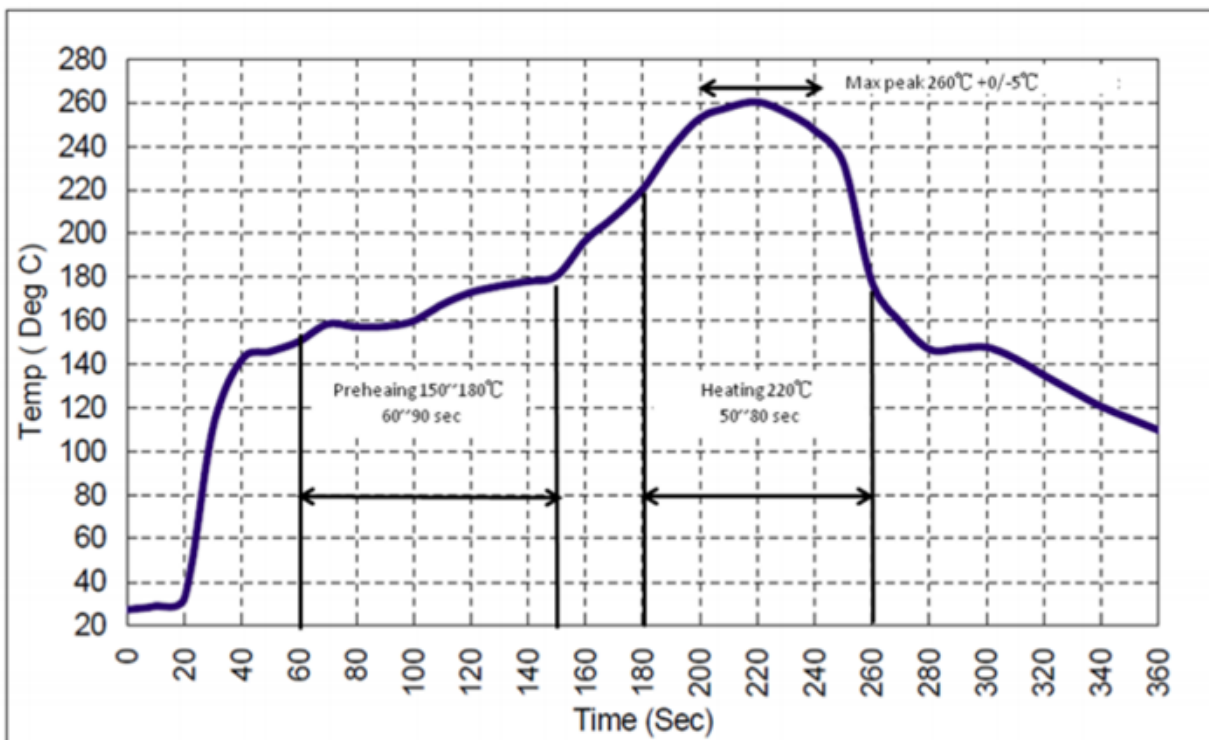
COMPONENT ORIENTATION and DIMENSIONS

Carrier Tape Dimensions	
Ao	3.35 mm
Bo	3.35 mm
Ko	1.40 mm
Pitch	8.0 mm
W	12.0 mm



Recommended Reflow Profile

1. Preheating shall be fixed at 150~180° for 60~90 seconds.
2. Ascending time to preheating temperature 150° shall be 30 seconds min.
3. Heating shall be fixed at 220°C for 50~80 seconds and at 260°C peak (10 seconds.)
4. Time: 5 times maximum



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